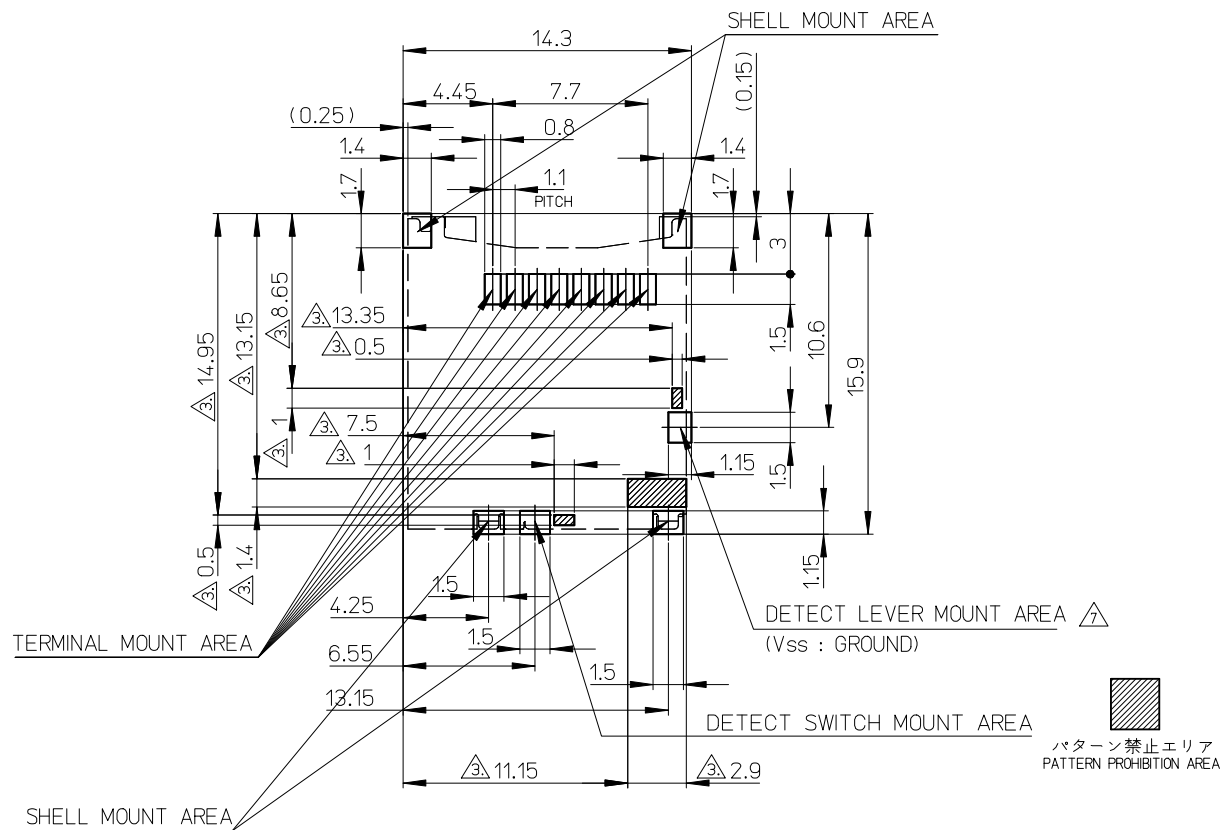


10 9 8 7 6 5 4 3 2 1



RECOMMENDED
PCB PATTERN LAYOUT
(GENERAL TOLERANCE : ±0.05)

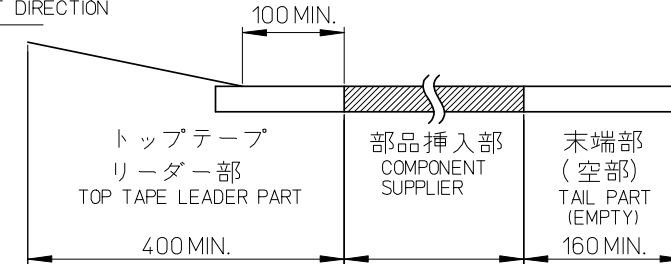
REVISED EC NO: J2009-2308 DRWN: CARIZONO 2009/04/17 CHKD: T. HARIYAMA 2009/04/17 APPR: NUKITA 2009/04/20 REV A	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY YMATSUMOTO	DATE 07/09/10	TITLE MICROSD CARD CONN. (P/P & NORMALSMALL TYPE)				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MTOMITA	DATE 07/09/10					
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 07/09/10	MOLEX MOLEX INCORPORATED				
		ANGULAR ±1 °		MATERIAL NO. SEE SHEET 1		DOCUMENT NO. SD-502570-001			SHEET NO. 2 OF 2	
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

NOTES

- 製品詳細寸法については、SD 図面を参照下さい。
RE DETAILED DIMENSION, SEE SALES DRAWING.
- 梱包数量：1300 個／リール
NUMBER OF CONNECTORS：1300 PCS/REEL.
- リードテープ長さ LEAD TAPE LENGTH.

トップテープ接着部
TOP TAPE BONDED PART.
(空エンボス)
(EMPTY)

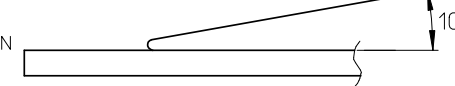
引き出し方向
PULL OUT DIRECTION



- トップテープの剥離強度：JIS C0806-3に準拠(剥離方向は下図参照)
尚、本規格値は出荷時に適用。(但し、輸送時に剥離が発生しないこと。)
PEELING OFF FORCE OF TOP TAPE: BASED UPON JIS C0806-3
(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT.
PEEL OFF SHOULD NOT BE ALLOWED, DURING TRANSPORTATION.

剥離方向
PEEL OFF DIRECTION

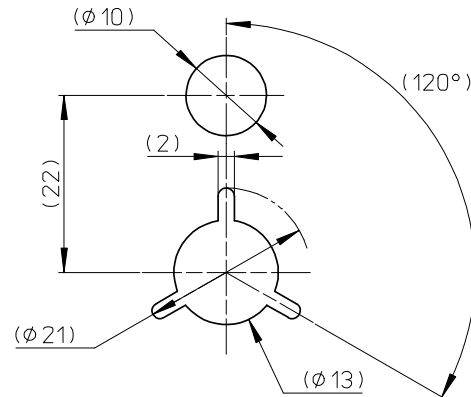
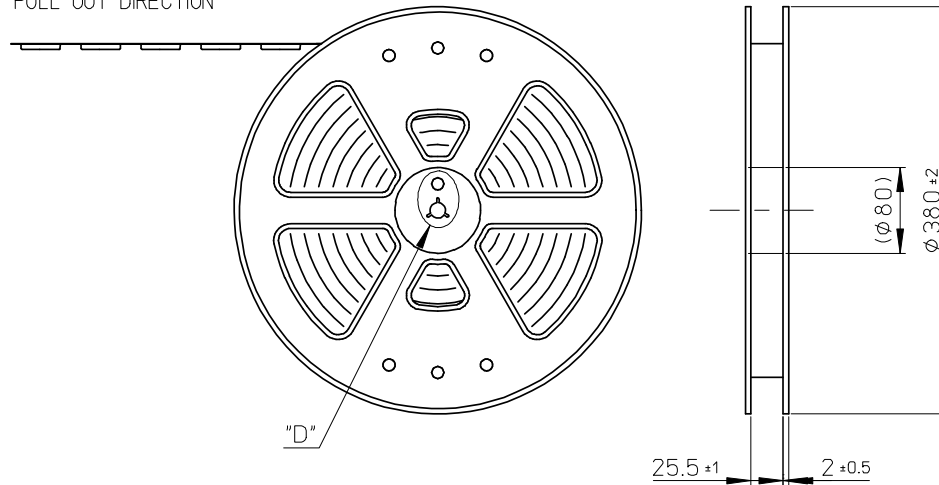
引き出し方向
PULL OUT DIRECTION



- 材料 MATERIAL
キャリアテープ (CARRIER TAPE)：ポリスチレン (POLYSTYRENE)
トップテープ (TOP TAPE)：PET, PE, PEF
リール (REEL)：ポリスチレン (PS) <リサイクル材含む>
POLYSTYRENE (PS)<RECYCLE MATERIAL CONTAINED>

8. ELV及びRoHS適合品 ELV AND RoHS COMPLIANT

引き出し方向
PULL OUT DIRECTION



DETAIL "D"

RELEASED EC NO: J2008-3223 2008/03/10 DRWN:HYAJIMA 2008/03/11 CHKD:THARUYAMA 2008/03/11 APPR:NUKITA	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER ± 0.2		DRAWN BY YMATSUMOTO		DATE 07/09/10		TITLE MICROSD CARD CONN. EMBOSSD TYPE PACKAGE FOR 502570-08**	
		10 OVER 30 UNDER ± 0.25		CHECKED BY MTOMITA		DATE 07/09/10			
		30 OVER ± 0.3		APPROVED BY MSASAO		DATE 07/09/10		MOLEX INCORPORATED	
		ANGULAR ±1 °		MATERIAL NO.		DOCUMENT NO.			
	0	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-502570-002		1 OF 2
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

10 9 8 7 6 5 4 3 2 1

F

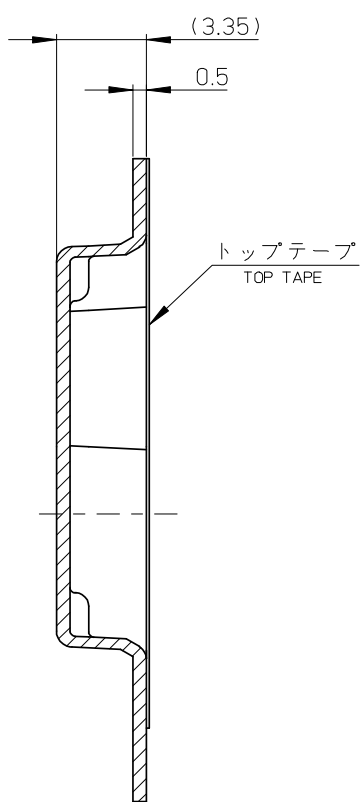
E

D

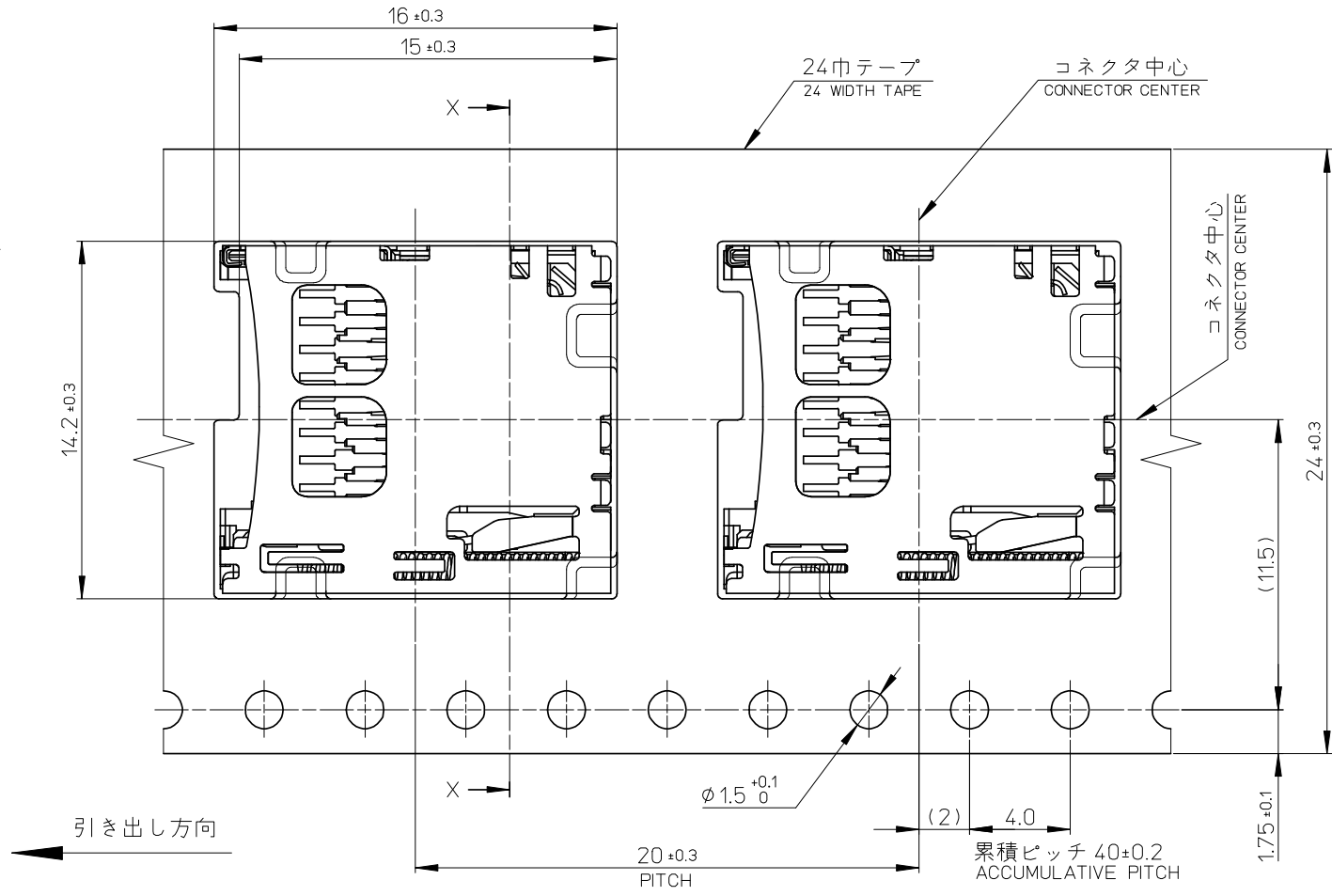
C

B



A



SECTION X-X



引き出し方向

RELEASED EC NO: J2008-3223 DRW:HYAJIMA 2008/03/10 CHKD:THARYAMA 2008/03/11 APPR:NUKITA 2008/03/11	DESCRIPTION REV 0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	MICROSD CARD CONN. EMBOSSD TYPE PACKAGE FOR 502570-08**  MOLEX INCORPORATED		
		10 UNDER	±0.2	DRAWN BY YMATSUMOTO	DATE 07/09/10	TITLE					
		10 OVER 30 UNDER	±0.25	CHECKED BY MTOMITA	DATE 07/09/10						
		30 OVER	±0.3	APPROVED BY MSASAO	DATE 07/09/10						
		ANGULAR ±1 °		MATERIAL NO.							DOCUMENT NO.
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHEET 1		SD-502570-002					2 OF 2
				SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						